

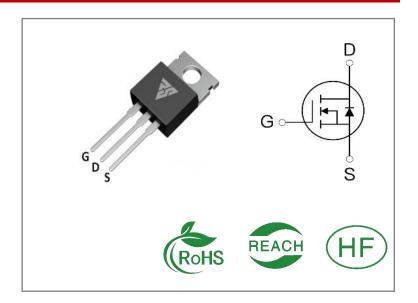
ID	R _{DS} (ON)(Typ)	VDSS
120A	2.8mΩ	40V

Applications:

- Load Switch
- PWM Applications
- Power Managment

Features:

- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability



Ordering Information

Part Number	Package	Marking	Packing	Qty.
RS40N120T	T0-220	RS40N120T	Tube	50 PCS

Absolute Maximun Ratings Tc= 25℃ unless otherwise specified

Symbol	Parameter	RS40N120T	Units
VDSS	Drain-to-Source Voltage	40	V
ID	Continuous Drain Current TC=25℃	120	
ID	Continuous Drain Current TC=100°C	76	A
IDM	Pulsed Drain Current	390	
PD	Power Dissipation	110	W
VGS	Gate- to- Source Voltage	±20	V
EAS	Single Pulse Avalanche Engergy L = 0.5mH,VDD = 40V, VG = 10V, Tj = 25℃	272	mJ
	Maximum Temperature for Soldering		
TL TPKG	Leads at 0.063in(1.6mm)from Case for 10 seconds Package Body for 10 seconds	300 260	°C
TJ and TSTG	Operating Junction and Storage Temperature Range	-55 to 150	

^{*} Drain Current Limited by Maximum Junction Temperature

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" Table may cause permanent damage to the device.



Thermal Resistance

Symbol	Parameter	RS40N120T	Units	Test Conditions
RθJC	Junction-to-Case	1.14	°C/W	Drain lead soldered to water cooled heatsink, PD adjusted for a peak junction temperature of + 1 5 0 $^{\circ}\mathrm{C}$
RθJA	Junction-to- Ambient	20		1 cubic foot chamber,free air.

OFF Characteristics TJ= 25 [°]C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BVDSS	Drain- to- source Breakdown Voltage	40			٧	VGS=0V,ID=250μA
IDSS	Drain- to- Source Leakage Current			1	μΑ	VDS=40V,VGS=0V
	Gate- to- Source Forward Leakage			100		VGS=20V ,VDS=0V
IGSS	Gate- to- Source Reverse Leakage			-100	nA	VGS=-20V ,VDS=0 V

ON Characteristics TJ=25 $^{\circ}$ C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
RDS(on) Static Drain- to- Source On- Resistance	Static Drain- to- Source On-		2.8	3.5	mΩ	VGS=10V,ID=15A
	Resistance		4.0	4.8	mΩ	VGS=4.5V,ID=10A
VGS(TH)	Gate Threshold Voltage	1.0		2.5	V	VGS=VDS,ID=250μ A

Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
td(ON)	Turn- on Delay Time		12		- nS	VDS=20V ID=20A RG=25Ω VGS=10V
trise	Rise Time		54			
td(OFF)	Turn- OFF Delay Time		120			
tfall	Fall Time		80			



Dynamic Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Ciss	Input Capacitance (10V)		4645			VGS= 0V
Coss	Output Capacitance (4.5V)		436		pF	VDS=20V
Crss	Reverse Transfer Capacitance		360			f=1.0MHz
0-	Total Gate Charge		102			
Qg	Total Gate Charge		49			VDS=20V
Qgs	Gate- to- Source Charge		15.8		nC	ID=20A VGS=10V
Qgd	Gate-to-Drain(" Miller") Charge		21.9			

Source-Drain Diode Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
IS	Continuous Source Current			120	Α	Integral pn- diode	
ISM	Maximum Pulsed Current			390	Α	in MOSFET	
VSD	Diode Forward Voltage			1.2	V	IS=15A,VGS=0V	
trr	Reverse Recovery Time		22.3		nS	VGS=0V	
Qrr	Reverse Recovery Charge		7.4		nC	IS=20A di/dt=100A/μs	

Notes

^{* 1.} Repetitive rating, pulse width limited by maximum junction temperature.

^{* 2.} Pulse Test: Pulse width ≤ 300µs, Duty Cycle ≤ 1%



Typical Feature Curve

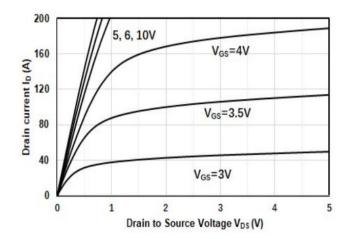


Figure 1. Output Characteristics

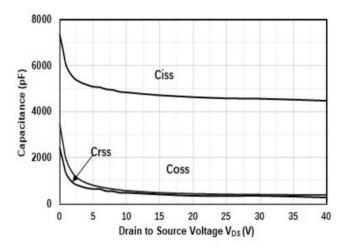


Figure 3. Capacitance Characteristics

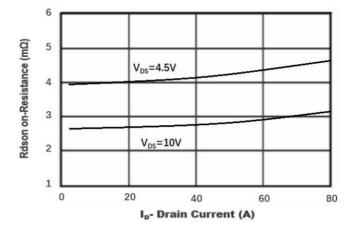


Figure 5. Drain-Source on Resistance

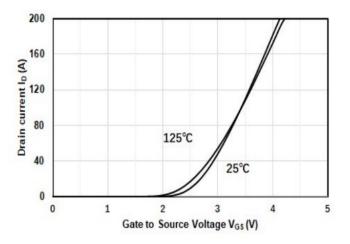


Figure 2. Transfer Characteristics

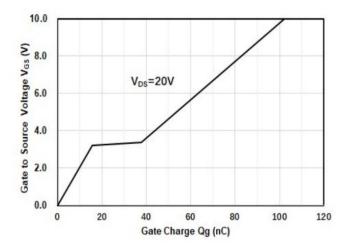


Figure4. Gate Charge

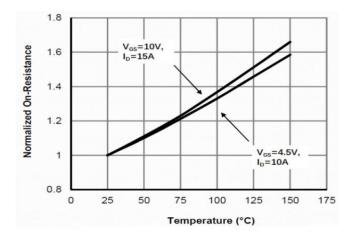
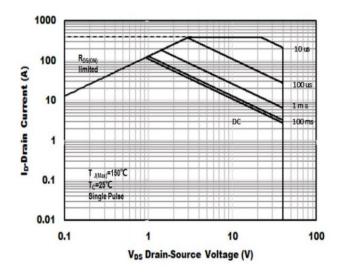


Figure6. Drain-Source on Resistance

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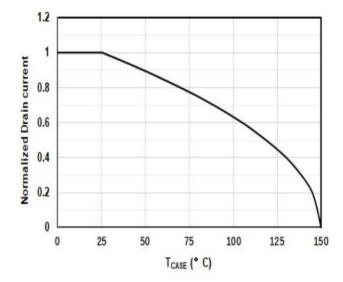


Figure 7. Safe Operation Area

Figure8. Drain current vs. Case Temperature

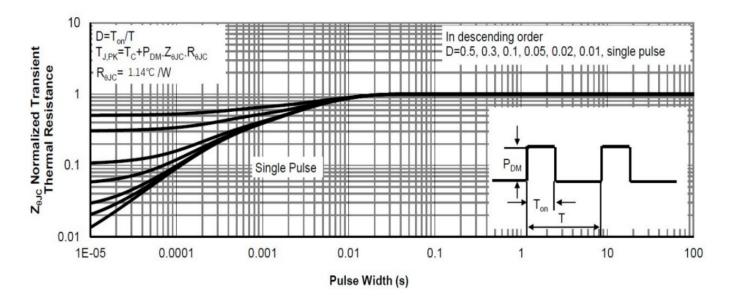


Figure 9. Normalized Maximum Transient Thermal Impedance

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Test ircuits and Waveforms

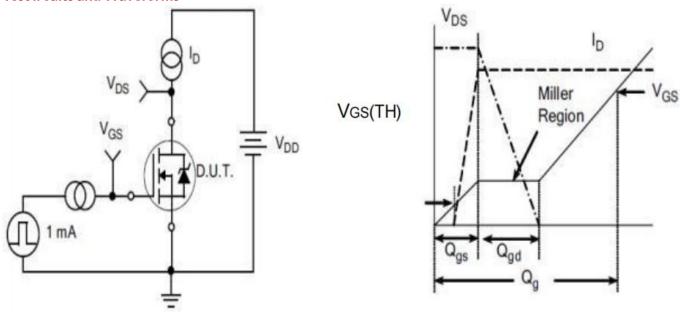


Figure A.
Gate Charge Test Circuit

V_{DS} V_{DS} 90% V_{DS} 10% V_{DS} 10%

Figure C.
Resistive Switching Test Circuit

Figure D.
Resistive Switching Waveforms

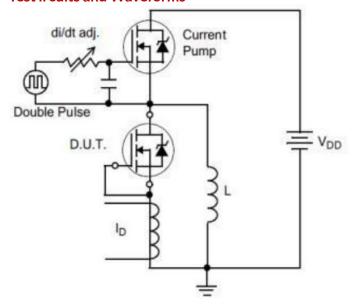
td(OFF) tfall

Figure B.

Gate Charge Waveform



Test ircuits and Waveforms



 $\frac{di/dt = 100A/\mu A}{di/dt}$

Figure E.Diode Reverse Recovery Test Circuit

BV_{DSS}

D.U.T.

Commutating Diode

V_{GS}

V_{DD}

Figure G.Unclamped Inductive Switching Test Circuit

Figure F.Diode Reverse Recovery Waveform

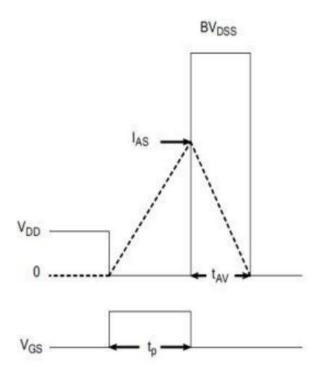
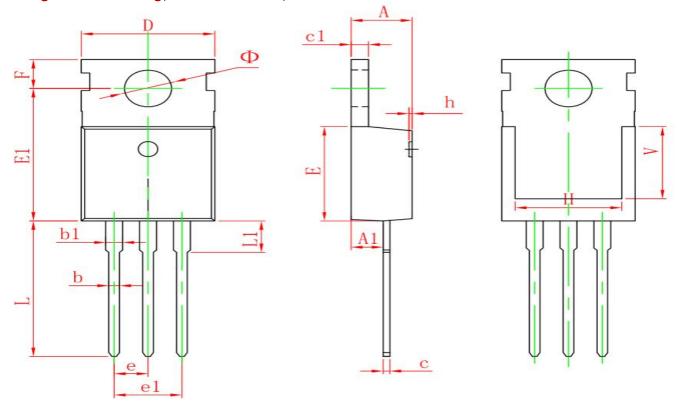


Figure H.Unclamped Inductive Switching Waveforms

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Package outline drawing(TO-220 Unit: mm)



Cumbal	Dimensions	In Millimeters	Dimension	s In Inches
Symbol	Min.	Max.	Min.	Max.
Α	4.400	4.600	0.173	0.181
A1	2.250	2.550	0.089	0.100
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
С	0.330	0.650	0.013	0.026
c1	1.200	1.400	0.047	0.055
D	9.910	10.250	0.390	0.404
E	8.950	9.750	0.352	0.384
E1	12.650	13.050	0.498	0.514
е	2.540	TYP.	0.100	TYP.
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
Н	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.900	13.400	0.508	0.528
L1	2.850	3.250	0.112	0.128
V	6.900	REF.	0.276	REF.
Ф	3.400	3.800	0.134	0.150



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DMN1017UCP3-7 EFC2J004NUZTDG P85W28HP2F-7071 DMN1053UCP4-7 NTE2384 DMC2700UDMQ-7 DMN2080UCB4-7
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DMN2990UFB-7B SSM3K35CT,L3F IPLK60R1K0PFD7ATMA1 2N7002W-G MCAC30N06Y-TP IPWS65R035CFD7AXKSA1
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